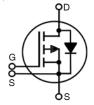


Preliminary Technical Information

TrenchP[™] Power MOSFET

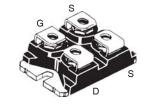
IXTN120P20T

P-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier



V _{DSS}	=	- 200V
D ₂₅	=	- 106A
R _{DS(on)}	≤	$30 \mathrm{m}\Omega$
t _{rr}	≤	300ns





G = Gate	D = Drain
S = Source	

Either Source Terminal S can be used as the Source Terminal or the Kelvin Source (Gate Return) Terminal.

Fe	atı	ures	

- International Standard Package
- Low Intrinsic Gate Resistance
- miniBLOC with Aluminum Nitride Isolation
- Avalanche Rated
- Extended FBSOA
- Fast Intrinsic Recitifier
- Low $R_{DS(ON)}$ and Q_{G}

Ad	van	taq	es

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Current Regulators
- Battery Charger Applications

Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	$T_{_{ m J}}$ = 25°C to 150°C	- 200	V	
V _{DGR}	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}, R_{GS} = 1\text{M}\Omega$	- 200	V	
V _{GSS}	Continuous	±15	V	
V _{GSM}	Transient	±25	V	
I _{D25}	T _C = 25°C	-106	A	
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	- 400	Α	
I _A E _{AS}	T _c = 25°C T _c = 25°C	-100 3	A J	
dv/dt	$I_{S} \le I_{DM}, V_{DD} \le V_{DSS}, T_{J} \le 150^{\circ}C$	10	V/ns	
P _D	T _C = 25°C	830	W	
T _J T _{JM} T _{stg}		-55 +150 150 -55 +150	ე° ე° ე°	
V _{ISOL}	50/60 Hz, RMS, $t = 1$ minute $I_{ISOL} \le 1$ mA, $t = 1$ s	2500 3000	V~ V~	
M _d	Mounting Torque for Base Plate Terminal Connection Torque	1.5/13 1.3/11.5	Nm/lb.in. Nm/lb.in.	
Weight		30	g	

SymbolTest ConditionsCharacteristics $(T_J = 25^{\circ}\text{C Unless Otherwise Specified})$ Min.		cteristic Values Typ. Max.				
BV _{DSS}	$V_{GS} = 0V, I_{D} = -250\mu A$		- 200			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		- 2.5		- 4.5	V
I _{GSS}	$V_{GS} = \pm 15V, V_{DS} = 0V$				±200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$	T _J = 125°C			- 25 - 300	•
R _{DS(on)}	$V_{GS} = -10V, I_{D} = 60A, Note 1$				30	mΩ



Symbol (T _J = 25°C	Test Conditions Unless Otherwise Specified)	Charac Min.	teristic Typ.	Values Max.
g _{fs}	V _{DS} = -10V, I _D = -60A, Note 1	85	145	S
C _{iss}			73	nF
C _{oss}	$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		2550	pF
C _{rss}			480	pF
t _{d(on)}			90	ns
t,	Resistive Switching Times		85	ns
t _{d(off)}	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = -60A$		200	ns
\mathbf{t}_{f}	$R_{g} = 1\Omega$ (External)		50	ns
$Q_{g(on)}$			740	nC
Q _{gs}	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = -60A$		220	nC
Q_{gd}			120	nC
R _{thJC}				0.15 °C/W
R _{thCS}			0.05	°C/W

SOT-227B (IXTN) Outline (M4 screws (4x) supplied) SYM INCHES MILLIMETERS MIN MAX MIN MAX A 1.240 1.253 31.50 31.88 B .307 .323 7.80 8.20 C .161 .169 4.09 4.29 D .161 .169 4.09 4.29 E .161 .169 4.09 4.29 E .161 .169 4.09 4.29 F .587 .595 14.91 15.11 G .1186 .1193 30.12 30.30 H .1496 .1505 38.00 38.23 J .460 .481 11.68 12.22 K .351 .378 8.92 9.60 L .030 .033 0.76 0.84 M .496 .506 12.60 12.85 N .990 1.001 25.15 25.42 O .078 .084 1.155 1.515 P .195 .235 4.95 5.97 Q .1045 1.059 26.54 26.90 N .990 1.001 25.15 25.42 O .078 .084 1.195 5.97 Q .1045 1.059 26.54 26.90 R .155 .174 3.94 4.42 S .186 .191 4.72 4.85 T .968 .987 24.59 25.07 U .002 .004 -0.05 0.1

Source-Drain Diode

Symbol	Test Conditions	Characteristic Values			
$(T_J = 25^{\circ}C)$	Unless Otherwise Specified)	Min.	Тур.	Max.	
Is	$V_{GS} = 0V$			-120	Α
I _{sm}	Repetitive, Pulse Width Limited by $T_{_{JM}}$			- 480	Α
V _{SD}	$I_F = -100A$, $V_{GS} = 0V$, Note 1			-1.4	V
t _{rr} Q _{RM} I _{RM}	$ \begin{cases} & I_F = -60A, -di/dt = -100A/\mu s \\ & V_R = -100V, V_{GS} = 0V \end{cases} $		3.3 25.6	300	ns µC A

Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

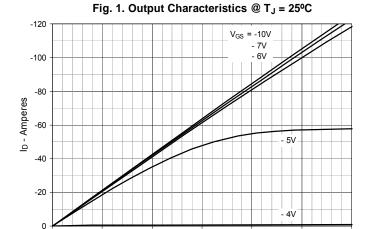
PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.



-0.5

-1

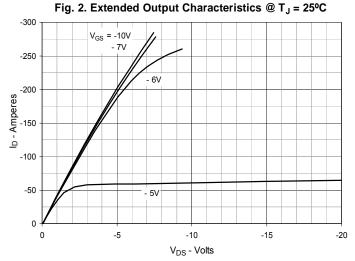


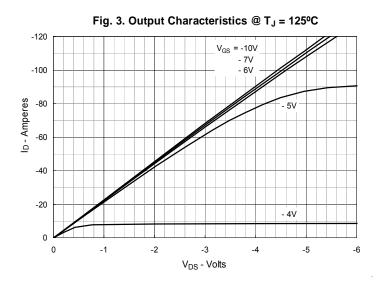
-1.5

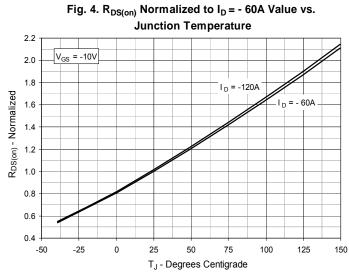
V_{DS} - Volts

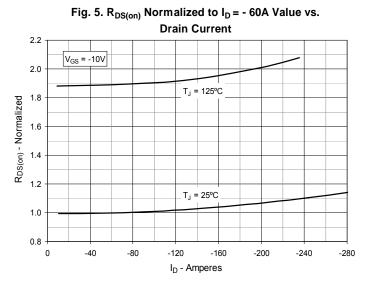
-2

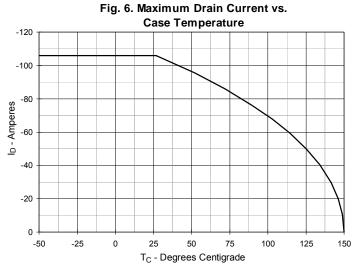
-2.5



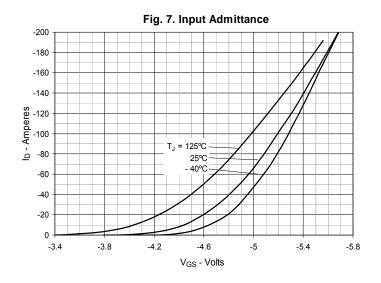


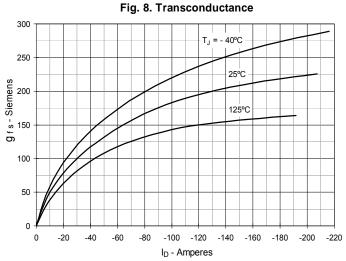


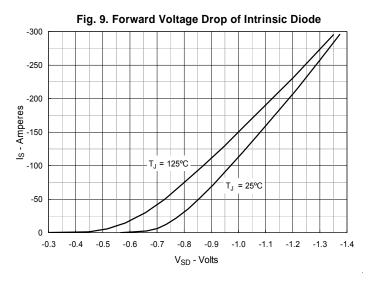


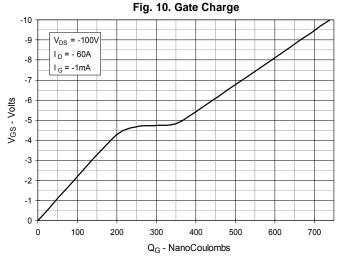


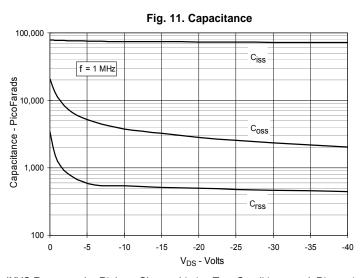


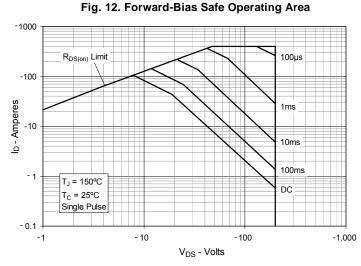












IXYS Reserves the Right to Change Limits, Test Conditions, and $\,$ Dimensions.



Fig. 13. Resistive Turn-on Rise Time vs.
Junction Temperature

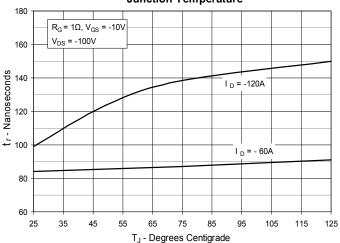


Fig. 14. Resistive Turn-on Rise Time vs.

Drain Current

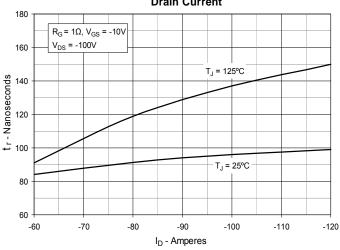


Fig. 15. Resistive Turn-on Switching Times vs.
Gate Resistance

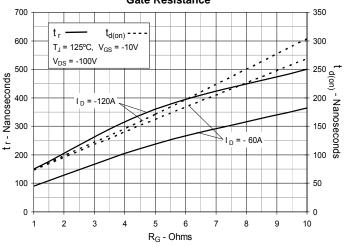


Fig. 16. Resistive Turn-off Switching Times vs.
Junction Temperature

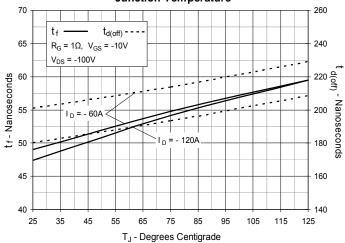


Fig. 17. Resistive Turn-off Switching Times vs.

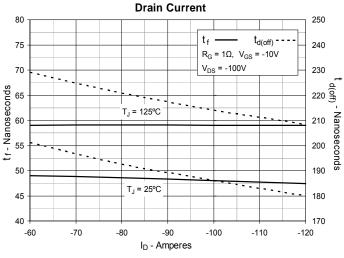
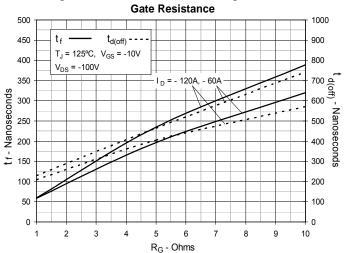


Fig. 18. Resistive Turn-off Switching Times vs.





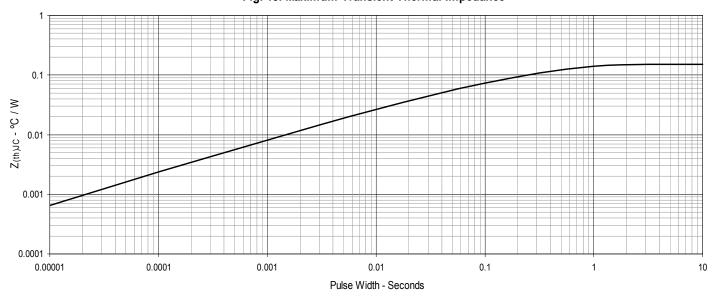


Fig. 19. Maximum Transient Thermal Impedance

